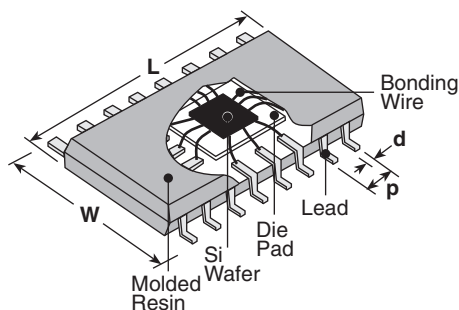




features

- Thin film construction
- Surface mount package
- Stable resistor density
- High resistor density
- Application specific design
- Products with lead-free terminations meet EU RoHS and China RoHS requirements

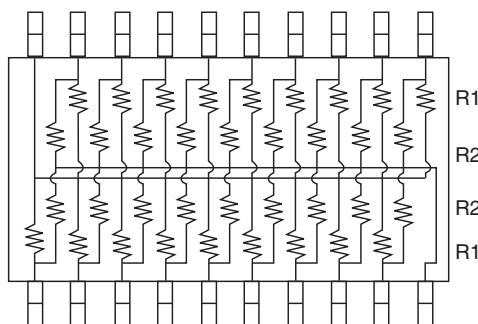
dimensions and construction



Package Code	Total Power	Pins	Dimensions inches (mm)				
			L ±0.2	W ±0.2	p ±0.1	H ±0.2	d ±0.05
Q16	0.8 watts	16	.193 (4.90)	.236 (5.99)	.025 (0.635)	—	—
Q20	1 watt	20	.341 (8.66)	.236 (5.99)	.025 (0.635)	.063 (1.60)	.010 (0.25)

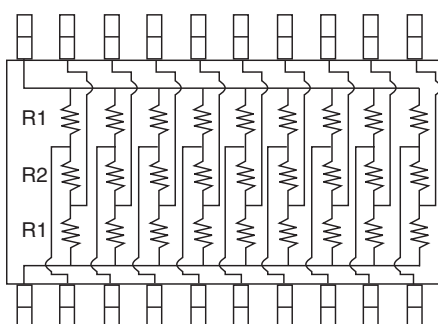
circuit schematic

ECL Terminator



RDA: 20 pins

SCSI Terminator



RDB: 20 pins

ordering information

New Part #	RDA	Q20	T	TEB	331J/221J	H
Type	RDA RDB	Package Code Reference above table	Termination Material T: Sn (Other termination styles available, contact factory for options)	Packaging TEB: 13" embossed plastic	R1 Value/R2 Value & Tolerance 3 digits J: ±5%	T.C.R. H: ±100

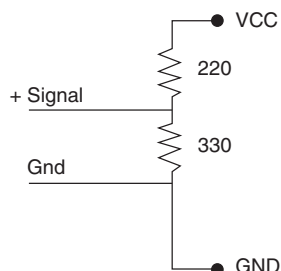
For further information on packaging, please refer to Appendix A.

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.

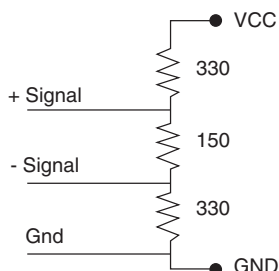
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application schematic

ESL Termination



SCSI termination



applications and ratings

Part Designation	Power Rating @ 70°C (Per Element)	T.C.R. (ppm/°C)	Resistance Range	Resistance Tolerance	Maximum Working Voltage	Operating Temperature Range
RDA RDB	50mW	±25%, ±50%, ±100	10Ω - 10,000Ω	±2%, ±5%	100V	-55°C to +155°C

environmental applications

Performance Characteristics

Parameter	Maximum ΔR	Test Method
Resistance to Soldering Heat	±0.2%	MIL-R-55342 4.7.7
Short Time Overload	+0.2%	MIL-R-55342 4.7.5
Moisture Resistance	±0.2%	MIL-STD-202 method 103
Thermal Shock	±0.2%	MIL-STD-202 method 107
H.A.S.T.	±0.5%	2 Atm., 121°C, 96 hrs